imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





SINGLE-ENDED OUTPUT SILICON OSCILLATOR

Features

- Quartz-free, MEMS-free, and PLL-free all-silicon oscillator Footprint compatible with industry-
- Any output frequencies from 0.9 to 200 MHz
- Short lead times
- Excellent temperature stability (±20 ppm)
- Highly reliable startup and operation
- High immunity to shock and vibration
- Low jitter: <1.5 ps rms
- 0 to 85 °C operation includes 10-year aging in hot environments
- Footprint compatible with industrystandard 3.2 x 5.0 mm XOs
- CMOS and SSTL versions available
- Driver stopped, tri-state, or powerdown operation
- RoHS compliant
- 1.8, 2.5, or 3.3 V options
- Low power
- More than 10x better fit rate than competing crystal solutions



Specifications

Parameters Condition		Min	Тур	Мах	Units
Frequency Range	uency Range		—	200	MHz
	Temperature stability, 0 to +70 °C	_	±10	_	ppm
Frequency Stability	Temperature stability, 0 to +85 °C	_	±20		ppm
Trequency Stability	Total stability, 0 to +70 °C operation ¹	_	-	±150	ppm
	Total stability, 0 to +85 °C operation ²	—	-	±250	ppm
	Commercial	0	—	70	°C
Operating Temperature	Extended commercial	0	— — —	85	°C
Storage Temperature		-55	—	+125	°C
	1.8 V option	1.71	—	1.98	V
Supply Voltage	2.5 V option	2.25	—	2.75	V
	3.3 V option	2.97	—	3.63	V

Notes:

1. Inclusive of 25 °C initial frequency accuracy, operating temperature range, supply voltage change, output load change, first-year aging at 25 °C, shock, vibration, and one solder reflow.

2. Inclusive of 25 °C initial frequency accuracy, operating temperature range, supply voltage change, output load change, ten-year aging at 85 °C, shock, vibration, and one solder reflow.

3. See "AN409: Output Termination Options for the Si500S and Si500D Silicon Oscillators" for further details regarding output clock termination recommendations.

4. $V_{TT} = .5 \times V_{DD}$.

5. $V_{TT} = .45 \times V_{DD}$.

Parameters	Condition	Min	Тур	Max	Units
	1.8 V option, 40 pF, 40 MHz, CMOS	_	13.9	16	mA
	1.8 V option, 10 pF, 200 MHz, CMOS	_	16.7	19	mA
	2.5 V option, 40 pF, 40 MHz, CMOS	—	15.8	18	mA
	2.5 V option, 10 pF, 200 MHz, CMOS	—	19.3	22	mA
	3.3 V option, 40 pF, 40 MHz, CMOS	—	17.7	20	mA
Supply Current	3.3 V option, 10 pF, 200 MHz, CMOS	—	21.5	24	mA
Supply Current	SSTL-3.3, 200 MHz	—	18.1	20.2	mA
	SSTL-2.5, 200 MHz		18.0	19.7	mA
	SSTL-1.8, 200 MHz		16.8	18.7	mA
	Output Stopped, CMOS		11.8	13.1	mA
	Tri-State	—	9.7	10.7	mA
	Powerdown	—	1.0	1.9	mA
Output Symmetry	0.5 x V _{DD}	46 – 13 ns/T _{CLK}	_	54 + 13 ns/T _{CLK}	%
Rise and Fall Times ³	CMOS, $C_L = 15 \text{ pF}$ measured from 20 to 80% of V_{DD}	_	1.4	2.0	ns
	SSTL	—	—	0.6	ns
CMOS Output Voltage	V _{OH} , sourcing 9 mA	$V_{DD} - 0.5$	—	_	V
	V _{OL} , sinking 9 mA	_	—	0.5	V
SSTL-1.8 Output Voltage ⁴	V _{OH}	V _{TT} + 0.375	—	—	v
	V _{OL}		_	V _{TT} – 0.375	v
SSTL-2.5 Output Voltage ⁴	V _{OH}	V _{TT} + 0.48	—	—	V
COTE 2.5 Calput Voltage	V _{OL}	—	—	V _{TT} – 0.48	•
SSTL-3.3 Output Voltage ⁵	V _{OH}	V _{TT} + 0.48	—	—	V
COTE C.C Calpar Voltage	V _{OL}	—	—	V _{TT} – 0.48	•
Powerup Time	From time V _{DD} crosses min spec supply	_	—	2	ms
OE Deassertion to Clk Stop		_	_	250 + 3 x T _{CLK}	ns
Return from Output Driver Stopped Mode		_	_	250 + 3 x T _{CLK}	ns
Return from Tri-State Time		_	—	12 + 3 x T _{CLK}	μs
Return from Powerdown Time			_	2	ms
Period Jitter (1-sigma)	SSTL ³	_	1	2	ps RMS
Integrated Phase Jitter	1 MHz – 0.4 x F _{OUT} , SSTL or CMOS and C _L \leq 7 pF, F _{OUT} > 2.5 MHz	_	0.7	1.5	ps RMS

Notes:

1. Inclusive of 25 °C initial frequency accuracy, operating temperature range, supply voltage change, output load change, first-year aging at 25 °C, shock, vibration, and one solder reflow.

2. Inclusive of 25 °C initial frequency accuracy, operating temperature range, supply voltage change, output load change, ten-year aging at 85 °C, shock, vibration, and one solder reflow.

3. See "AN409: Output Termination Options for the Si500S and Si500D Silicon Oscillators" for further details regarding output clock termination recommendations.

4. $V_{TT} = .5 \times V_{DD}$. **5.** $V_{TT} = .45 \times V_{DD}$.



Package Specifications

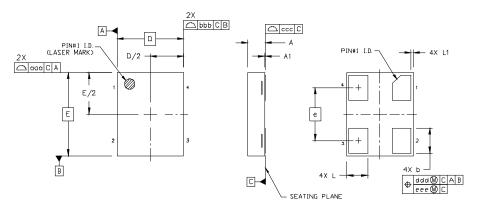


Table 1. Package Diagram Dimensions (mm)

Dimension	Min	Nom	Max
А	0.80	0.85	0.90
A1	0.00 0.03		0.05
b	1.15	1.25	
D	3.20 BSC		
е	2.54 BSC		
E	4.00 BSC		
L	0.95	1.00	1.05

Dimension	Min	Nom	Max
L1	0.00	0.05	0.10
aaa			0.10
bbb			0.10
CCC			0.08
ddd			0.10
eee			0.05

Table 2. Pad Connections

1	OE
2	GND
3	Output
4	VDD

Table 3. Tri-State/Powerdown/Driver Stopped Function on OE (3rd Option Code)

	Α	В	С	D	E	F
Open	Active	Active	Active	Active	Active	Active
1 Level	Active	Tri- State	Active	Power- down	Active	Driver Stopped
0 Level	Tri- State	Active	Power- down	Active	Driver Stopped	Active

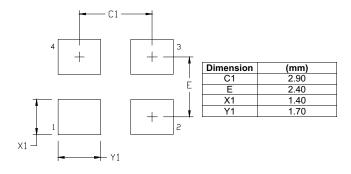
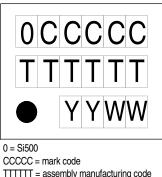


Figure 1. Recommended Land Pattern





TTTTT = assembly manufacturing code YY = year WW = work week

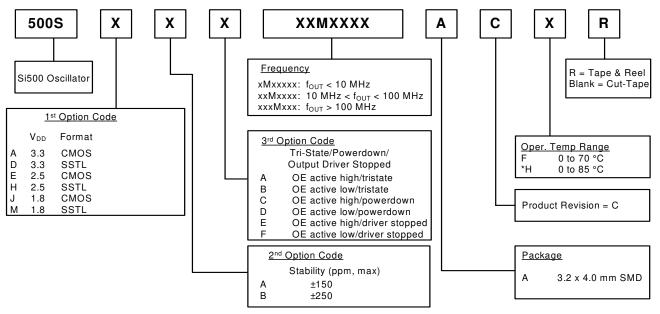
Figure 2. Top Mark

Environmental Compliance

Parameter	Conditions/Test Method		
Mechanical Shock	MIL-STD-883, Method 2002.4		
Mechanical Vibration	MIL-STD-883, Method 2007.3 A		
Resistance to Soldering Heat	MIL-STD-202, 260 C° for 8 seconds		
Solderability	MIL-STD-883, Method 2003.8		
Damp Heat	IEC 68-2-3		
Moisture Sensitivity Level	J-STD-020, MSL 3		

Ordering Information

The Si500S supports a variety of options including frequency, output format, supply voltage, and tristate/powerdown/output driver stopped mode. Specific device configurations are programmed into the Si500S at time of shipment. Configurations are specified using the figure below. Silicon Labs provides a web-based part number utility that can be used to simplify part number configuration. Refer to www.silabs.com/SiliconXOPartnumber to access this tool. The Si500S silicon oscillator is supplied in a ROHScompliant, 4-pad, 3.2 x 4.0 mm package. Tape and reel packaging is available as an ordering option.



*Note: Only <u>+</u>250 ppm is supported.



DOCUMENT CHANGE LIST

Revision 0.3 to Revision 0.4

- Revision B to Revision C updated in Ordering Information
- 0 to 85 C° Operating Temperature Range option added
- Multiple CMOS output format codes removed

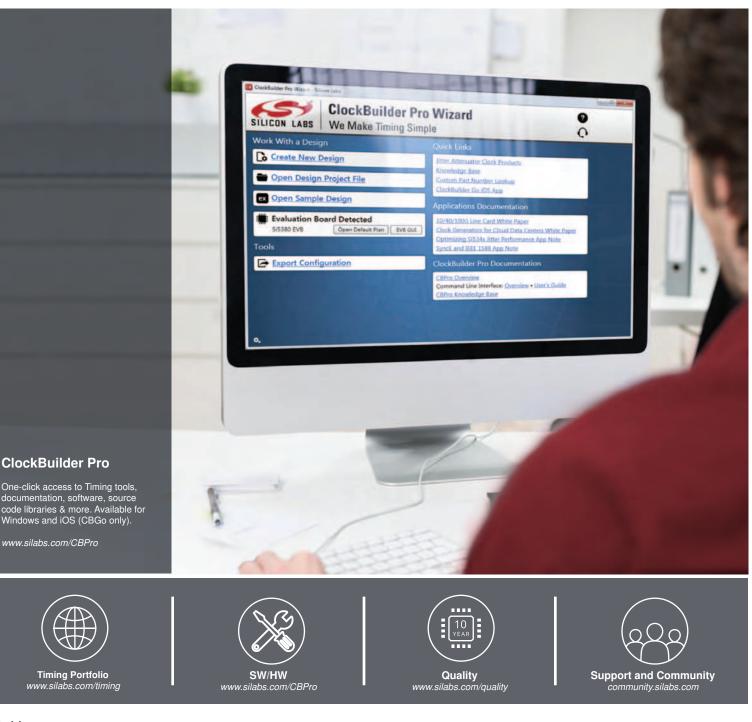
Revision 0.4 to Revision 1.0

- Clarified SSTL specifications.
- Revised CMOS supply current max values .

Revision 1.0 to Revision 1.1

- Updated Ordering information for ±250 ppm from 0 to +85 °C.
- Updated jitter from 1.5 ps to 1.5 ps rms.
- Updated operating temperature to include extended commercial at 0 to +85 °C.





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Silicon Laboratories Inc. 400 West Cesar Chavez Austin, TX 78701 USA

http://www.silabs.com